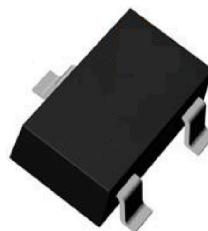
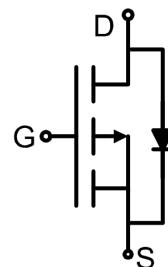


**Package****Feature**

- Advanced trench process technology
- High density cell design for ultra low on-resistance

**SOT-23****Application**

- Load Switch for Portable Devices
- DC/DC Converter

**Marking: A1SHB****Circuit diagram****Absolute maximum ratings (Ta=25°C unless otherwise noted)**

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V <sub>DS</sub>	-20	V
Gate-Source Voltage	V <sub>GS</sub>	±10	V
Continuous Drain Current	I <sub>D</sub>	-3.4	A
Pulsed Drain Current	I <sub>DM</sub>	-14	A
Power Dissipation	P <sub>D</sub>	1	W
Junction Temperature	T <sub>J</sub>	150	°C
Storage Temperature	T <sub>STG</sub>	-55 ~ +150	°C

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**Electrical characteristics ( $T_A=25^\circ\text{C}$ , unless otherwise noted)**

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
<b>Static Characteristics</b>						
Drain-source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = -250\mu\text{A}$	-20			V
Zero gate voltage drain current	$I_{\text{DSS}}$	$V_{\text{DS}} = -20\text{V}, V_{\text{GS}} = 0\text{V}$			-1	$\mu\text{A}$
Gate-body leakage current	$I_{\text{GSS}}$	$V_{\text{GS}} = \pm 10\text{V}, V_{\text{DS}} = 0\text{V}$			$\pm 100$	nA
Gate threshold voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = -250\mu\text{A}$	-0.4		-1.0	V
` Drain-source on-resistance <sup>1)</sup>	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = -4.5\text{V}, I_D = -3.4\text{A}$			64	$\text{m}\Omega$
		$V_{\text{GS}} = -2.5\text{V}, I_D = -3.0\text{A}$			80	
		$V_{\text{GS}} = -1.8\text{V}, I_D = -2.5\text{A}$			95	
<b>Dynamic characteristics<sup>2)</sup></b>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{DS}} = -10\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$		550		pF
Output Capacitance	$C_{\text{oss}}$			89		
Reverse Transfer Capacitance	$C_{\text{rss}}$			65		
Total Gate Charge	$Q_g$	$V_{\text{DS}} = -10\text{V}, V_{\text{GS}} = -4.5\text{V}, I_D = -3.4\text{A}$		4.3		nC
Gate-Source Charge	$Q_{\text{gs}}$			0.8		
Gate-Drain Charge	$Q_{\text{gd}}$			1.1		
Turn-on delay time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = -10\text{V}, V_{\text{GS}} = -4.5\text{V}, I_D = -1\text{A}, R_{\text{GEN}} = 2.5\Omega$		12		nS
Turn-on rise time	$t_r$			54		
Turn-off delay time	$t_{\text{d}(\text{off})}$			15		
Turn-off fall time	$t_f$			9		
<b>Source-Drain Diode characteristics</b>						
Diode Forward Current <sup>1)</sup>	$I_s$				-3.4	A
Diode Forward voltage	$V_{\text{DS}}$	$V_{\text{GS}} = 0\text{V}, I_s = -3.4\text{A}$			-1.2	V

Notes:

- 1) Pulse Test: Pulse Width < 300μs, Duty Cycle ≤ 2%.
- 2) Guaranteed by design, not subject to production testing.

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